

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

2SA2210 — PNP Epitaxial Planar Silicon Transistor High-Current Switching Applications

Applications

· Relay drivers, lamp drivers, motor drivers.

Features

- · Adoption of MBIT processes
- · Low collector-to-emitter saturation voltage
- · Large current capacitance
- · High-speed switching

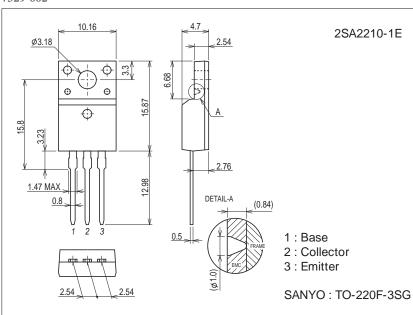
Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		-50	V
Collector-to-Emitter Voltage	VCEO		-50	V
Emitter-to-Base Voltage	VEBO		-6	V
Collector Current	IC		-20	Α
Collector Current (Pulse)	ICP		-25	Α
Base Current	IB		-3	Α
Collector Dissipation	Do.		2	W
	PC	Tc=25°C	30	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Package Dimensions

unit : mm (typ) 7529-002



Product & Package Information

• Package : TO-220F-3SG

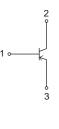
• JEITA, JEDEC : SC-67

• Minimum Packing Quantity

: 50 pcs./magazine

Marking Electrical Connection

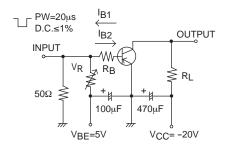




Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit	
Farameter	Symbol	Conditions	min	typ	max	Offile	
Collector Cutoff Current	ІСВО	V _{CB} = -40V, I _E =0A			-10	μΑ	
Emitter Cutoff Current	IEBO	V _{EB} = -4V, I _C =0A			-10	μΑ	
DC Current Gain	hFE	V _{CE} = -2V, I _C = -1A	150		450		
Gain-Bandwidth Product	fT	V _{CE} = -10V, I _C = -1A		140		MHz	
Output Capacitance	Cob	V _{CB} = -10V, f=1MHz		215		pF	
Collector-to-Emitter Saturation Voltage	V _{CE} (sat)	I _C = -7A, I _B = -350mA		-200	-500	mV	
Base-to-Emitter Saturation Voltage	V _{BE} (sat)	I _C = -7A, I _B = -350mA			-1.2	V	
Collector-to-Base Breakdown Voltage	V(BR)CBO	I _C = -100μA, I _E =0A	-50			V	
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	IC= -1mA, RBE=∞	-50			V	
Emitter-to-Base Breakdown Voltage	V(BR)EBO	IE= -100μA, IC=0A	-6			V	
Turn-On Time	ton			60		ns	
Storage Time	t _{stg}	See specified Test Circuit		270		ns	
Fall Time	tf			20		ns	

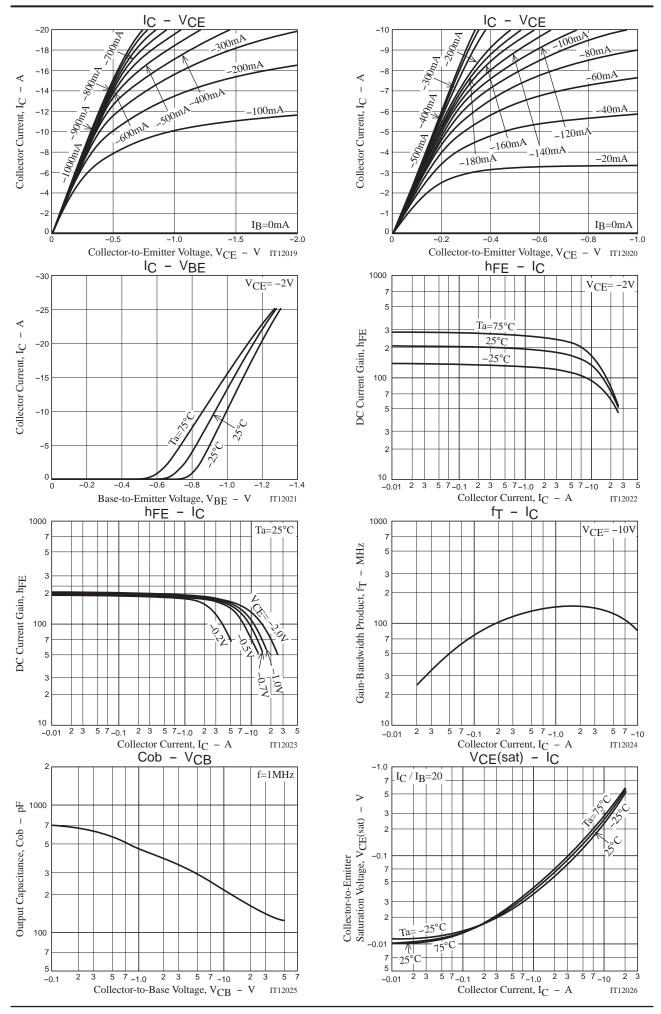
Switching Time Test Circuit

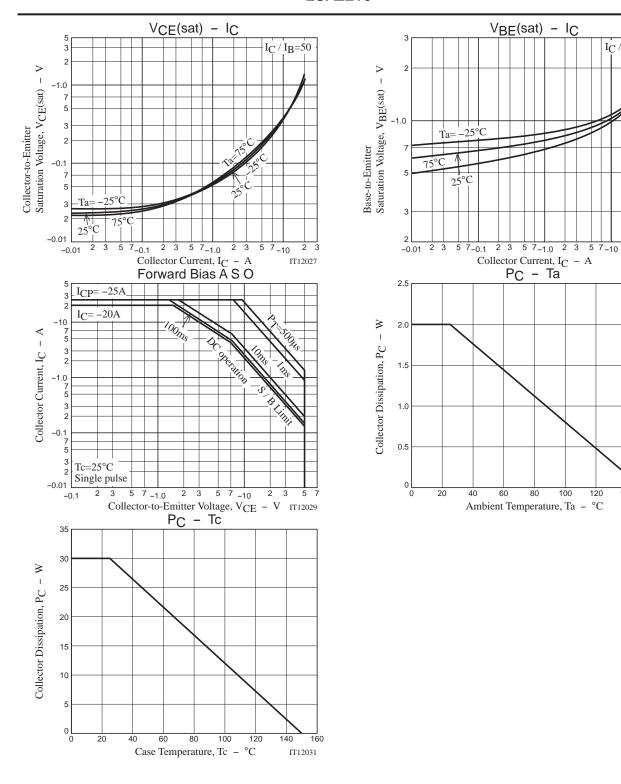


 $I_{C}=20I_{B1}=-20I_{B2}=-7A$

Ordering Information

Device	Package	Shipping	memo	
2SA2210-1E	TO-220F-3SG	50pcs./magazine	Pb Free	





 $I_C / I_B = 20$

IT12028

140

160

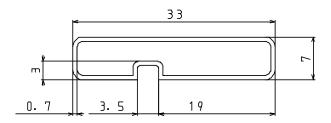
IT12030

Magazine Specification

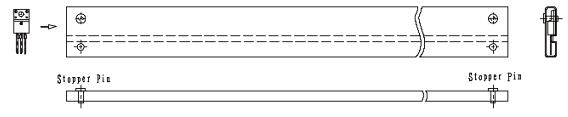
2SA2210-1E

1. Packing Format

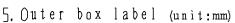
Packaga Name Magazine Nama		Maximum Number of devices contained (pcs)			Packing format		
1 4 4 4 4 4 1 4 4 4 4	Ida 9 a b i a c i i a a a	l	Inner box	Outer box	Inner BOX	Outer BOX	
TO-220F-3SG	TO-220F	50	1, 000	4,000	SPD-0V0001 20 magazines contained Dimensions:mm (external) 568×150×55	SPT-081029 4 inner boxes contained Dinensions:mm (external) 590×225×178	



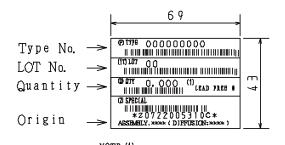
3. Storage method to magazine

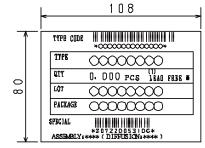


4. Inner box label (unit:mm)



It is a label at the time of factory shipments. The form of a label may change in physical distribution process.



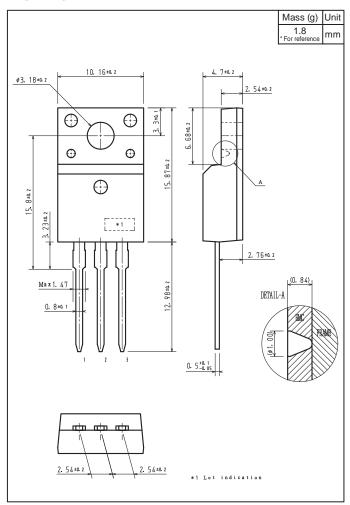


The LEAD FRRE * description shows that the surface treatment of the terminal is lead free.

Label		JEITA Phase		
LEAD FREE	3	JEITA Phase 3A		

Outline Drawing

2SA2210-1E



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